

# OAK4-SoM-MAX DEV-KIT specs/datasheet:

**Operating voltage:** PoE+ 802.3at, USB PD 30W min, DC PWR in 8-20 V, min 30W.

**Peak operating power:** 30 W

**Operating temperature:** 10-30 degC

## Peripherals:

- ETH PHY, 2.5G bps, RJ45 connector, PoE+ input
- M.2 connector:
  - E.key :
    - SDC connection
    - UART connection
    - Separate PS, needs to be enabled in FW
    - Up to 80mm long modules
  - M.key
    - PCIe GEN 4
    - Meant mostly for SSD
    - Separate PS, needs to be enabled in FW
    - Up to 80mm long modules
- USB-C type connector
  - UART debug, 115200 baud, 8N1
- USB-C
  - USB3.0 speed
  - Integrated USB PD sink 30W
  - Integrated USB PD source, 5V only up to 1A
- DC input jack
  - Power supply
- 6 CSI ports
  - 4 pcs 2 lane MIPI
  - 2 pcs 4 lane MIPI
- uSD card V6.0 support
- SPI, UART, I2C, I2S available on 2.54mm headers, 1V8 logic levels
- CAN interface
  - 3 pin 5.08mm screw terminal
  - Removable 120R termination
- M8 connector, same as on OAK4-D (5V, GND, USB 2.0, UART, Fsync).
- RGB status LED
- Connector for 5V fan for cooling SoM, should be included in package
- 4 MICS over I2S
- IMU, gyro, light and barometer sensors
- 10 FFC connector for DoT CBA connection
- PSRBS connector
- Power consumption meter on 3V9V rail (SoM) and on 5V rail (INA700)

- JTAG exposed, 10 pin FFC connector

**Cooling of the SoM:**

We have used an RPi 4 cooling tower that can be mounted and powered from DEV-KIT. For instructions, how to mount it, please refer to *Getting started with OAK4-DEV-KIT R4D0* document.

**Dimensions** for mounting can be found in the following picture. For any extra dimensions please refer to the .dwg file or .step model of the DEV-KIT placed in the same folder as this document.

Mounting holes have a diameter of 3mm (for M2.5 screw) and are spaced in a 159\*110mm rectangle. Total outside dimension of PCB is 8mm bigger on each axis, so 167\*118mm. PCB weighs 145g, including corner standoffs, excluding SoM and M.2 modules.

